5075 series

VCXO Module IC with Built-in Varicap

OVERVIEW

The 5075 series are miniature VCXO ICs that provide a wide frequency pulling range, even when using miniature crystal units for which a wide pulling range is difficult to provide. They employ a recently developed varicap diode fabrication process that provides a wide frequency pulling range and good linearity without any external components. Also, they employ a regulated voltage drive oscillator circuit that significantly reduces current consumption, crystal current, and oscillation characteristics supply voltage dependency. The 5075 series are ideal for miniature, wide pulling range, low power consumption, VCXO modules.

FEATURES

- VCXO with recently developed varicap diode built-in
- New fabrication process that significantly reduces parasitic capacitance and provides wide pulling range even when using miniature crystal units
- Regulated voltage drive oscillator circuit for reduced power consumption, crystal drive current, and oscillation characteristics voltage dependency
- Wide frequency pulling range
  - ± 190ppm (B1 version, f = 27MHz)
    (Crystal: γ = 300, C0 = 1.5pF)
- Operating supply voltage range: 2.25V to 3.63V
- Oscillation frequency range (for fundamental oscillation): 20MHz to 55MHz (varies with version)
- Low current consumption: 1.0mA
  (B1 version, f = 27MHz, no load, V_{DD} = 3.3V)
- Frequency divider built-in
  - Selectable by version: f_O, $f_O/2$, $f_O/4$, $f_O/8$, $f_O/16$
  - Frequency divider output for 1.3MHz (min) low frequency output
- VC pin input resistance: 10MΩ (min)
- CMOS output
- Two types of pad layout selectable by mounting method
  - A× version: for Flip Chip Bonding
  - B× version: for Wire Bonding
- Package: Wafer form (WF5075××)
  Chip form (CF5075××)

APPLICATIONS

- 2.5 × 2.0mm, 3.2 × 2.5mm size miniature VCXO modules for digital mobile TV tuner, digital TV (PDP, LCD), PND (Personal Navigation Device), etc.

ORDERING INFORMATION

Device	Package
WF5075××–4	Wafer form
CF5075××–4	Chip form

SERIES CONFIGURATION

Operating supply voltage range [V]	PAD layout	Recommended operating frequency range*1 [MHz]	Output frequency and version name*2				
			f_O output	f_O/2 output	f_O/4 output	f_O/8 output	f_O/16 output
2.25 to 3.63	Flip Chip Bonding	20 to 40	(5075A1)	(5075A2)	(5075A3)	(5075A4)	(5075A5)
		40 to 55	(5075AJ)	(5075AK)	(5075AL)	(5075AM)	(5075AN)
	Wire Bonding	20 to 40	5075B1	(5075B2)	(5075B3)	(5075B4)	(5075B5)
		40 to 55	5075BJ	(5075BK)	(5075BL)	(5075BM)	(5075BN)

*1. The recommended operating frequency is a yardstick value derived from the crystal used for NPC characteristics authentication. However, the oscillation frequency range is not guaranteed. Specifically, the characteristics can vary greatly due to crystal characteristics and mounting conditions, so the oscillation characteristics of components must be carefully evaluated.

*2. Versions in parentheses ( ) are under development.

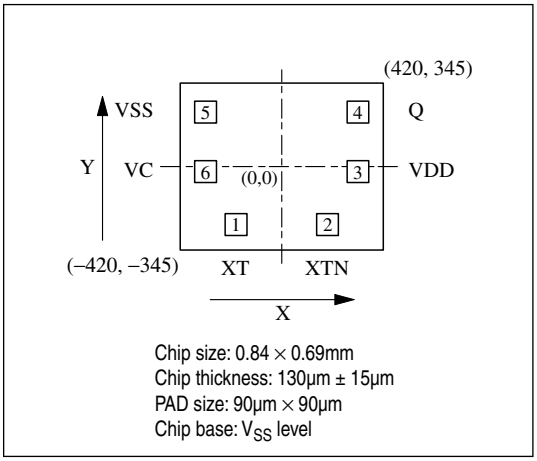
VERSION NAME

Device	Package	Version name
WF5075××–4	Wafer form	WF5075□□–4 Form WF: Wafer form CF: Chip (Die) form Oscillation frequency range, frequency divider function Pad layout type A: for Flip Chip Bonding B: for Wire Bonding
CF5075××–4	Chip form	

PAD LAYOUT

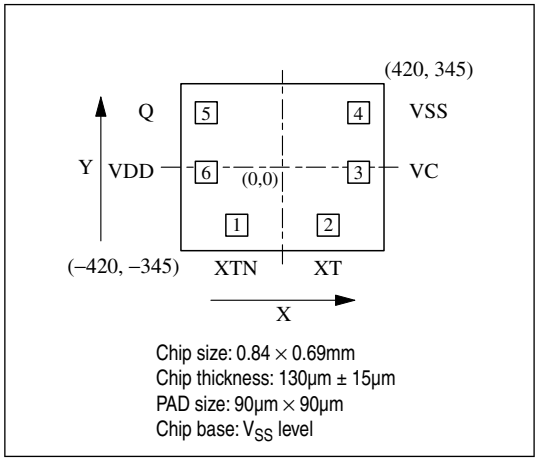
(Unit: µm)

■ 5075A× (for Flip Chip Bonding)



Chip size: 0.84 × 0.69mm
Chip thickness: 130µm ± 15µm
PAD size: 90µm × 90µm
Chip base: V_{SS} level

■ 5075B× (for Wire Bonding)



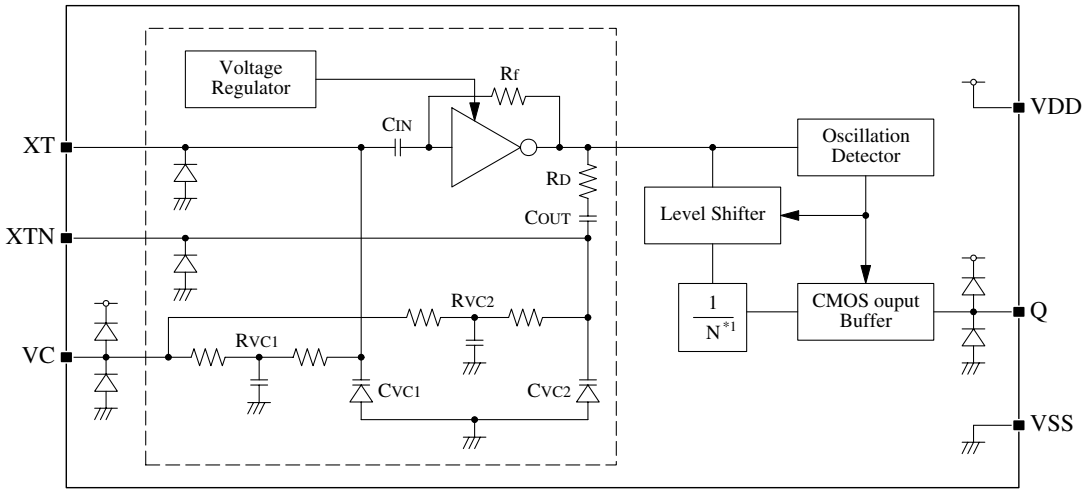
Chip size: 0.84 × 0.69mm
Chip thickness: 130µm ± 15µm
PAD size: 90µm × 90µm
Chip base: V_{SS} level

PAD DIMENSIONS PIN DESCRIPTION

Pad No.	Pad dimensions [µm]	
	X	Y
1	–189	–240
2	189	–240
3	315	–21
4	315	225
5	–315	225
6	–315	–21

Pad No.		Pin	I/O	Description
5075A×	5075B×			
1	2	XT	I	Crystal connection pin (amplifier input)
2	1	XTN	O	Crystal connection pin (amplifier output)
3	6	VDD	–	(+) supply pin
4	5	Q	O	Clock output pin
5	4	VSS	–	(–) supply pin
6	3	VC	I	Oscillation frequency control voltage input pin (positive polarity) (frequency increases with increasing voltage)

BLOCK DIAGRAM



*1. N = 1, 2, 4, 8, 16

ABSOLUTE MAXIMUM RATINGS

V_{SS} = 0V

Parameter	Symbol	Conditions	Rating	Unit
Supply voltage range	V_{DD}	Between VDD and VSS	–0.5 to 7.0	V
Input voltage range	V_{IN}	Input pins	–0.5 to V_{DD} + 0.5	V
Output voltage range	V_{OUT}	Output pins	–0.5 to V_{DD} + 0.5	V
Storage temperature range	T_{STG}	Wafer form, chip form	–65 to +150	°C
Output current	I_{OUT}	Q pin	20	mA

RECOMMENDED OPERATING CONDITIONS

V_{SS} = 0V

Parameter	Symbol	Conditions		Rating			Unit
				Min	Typ	Max	
Operating supply voltage	V_{DD}	$C_{LOUT} \leq$ 15pF		2.25	–	3.63	V
Input voltage	V_{IN}	Input pins		V_{SS}	–	V_{DD}	V
Operating temperature	T_{OPR}			–40	–	+85	°C
Oscillation frequency*1	f_O	5075×1 to 5075×5		20	–	40	MHz
		5075×J to 5075×N		40	–	55	MHz
Output frequency	f_{OUT}	$C_{LOUT} \leq$ 15pF	5075×1 to 5075×5	1.25	–	40	MHz
			5075×J to 5075×N	2.5	–	55	MHz

*1. The oscillation frequency is a yardstick value derived from the crystal used for NPC characteristics authentication. However, the oscillation frequency range is not guaranteed. Specifically, the characteristics can vary greatly due to crystal characteristics and mounting conditions, so the oscillation characteristics of components must be carefully evaluated.

ELECTRICAL CHARACTERISTICS

5075×1 to 5075×5

V_{DD} = 2.25 to 3.63V, $V_C = 0.5V_{DD}$, V_{SS} = 0V, Ta = –40 to +85°C unless otherwise noted.

Parameter	Symbol	Conditions		Rating			Unit
				Min	Typ	Max	
Current consumption	I_{DD}	5075×1 (f_O), Measurement circuit 1, no load, f_O = 27MHz, f_{OUT} = 27MHz	V_{DD} = 2.5V	–	0.7	1.4	mA
			V_{DD} = 3.3V	–	1.0	2.0	mA
		5075×2 (f_O/2), Measurement circuit 1, no load, f_O = 27MHz, f_{OUT} = 13.5MHz	V_{DD} = 2.5V	–	0.6	1.2	mA
			V_{DD} = 3.3V	–	0.8	1.6	mA
		5075×3 (f_O/4), Measurement circuit 1, no load, f_O = 27MHz, f_{OUT} = 6.75MHz	V_{DD} = 2.5V	–	0.5	1.0	mA
			V_{DD} = 3.3V	–	0.7	1.4	mA
		5075×4 (f_O/8), Measurement circuit 1, no load, f_O = 27MHz, f_{OUT} = 3.38MHz	V_{DD} = 2.5V	–	0.5	1.0	mA
			V_{DD} = 3.3V	–	0.6	1.2	mA
		5075×5 (f_O/16), Measurement circuit 1, no load, f_O = 27MHz, f_{OUT} = 1.69MHz	V_{DD} = 2.5V	–	0.4	0.8	mA
			V_{DD} = 3.3V	–	0.6	1.2	mA
HIGH-level output voltage	V_{OH}	Q pin, Measurement circuit 2, I_{OH} = –2.8mA		V_{DD} – 0.4	–	–	V
LOW-level output voltage	V_{OL}	Q pin, Measurement circuit 2, I_{OL} = 2.8mA		–	–	0.4	V
Oscillator block built-in resistance	R_{VC1}	Measurement circuit 3		210	420	840	kΩ
	R_{VC2}			210	420	840	kΩ
Oscillator block built-in capacitance	C_{VC1}	Design value (a monitor pattern on a wafer is tested), Excluding parasitic capacitance.	V_C = 0.3V	–	5.6	–	pF
			V_C = 1.65V	–	3.1	–	pF
			V_C = 3.0V	–	1.5	–	pF
	C_{VC2}		V_C = 0.3V	–	8.4	–	pF
			V_C = 1.65V	–	4.7	–	pF
			V_C = 3.0V	–	2.3	–	pF
VC input resistance	R_{VIN}	Measurement circuit 4, Ta = 25°C		10	–	–	MΩ
VC input impedance	Z_{VIN}	Measurement circuit 5, V_C = 0V, f = 10kHz, Ta = 25°C (a monitor pattern on a wafer is tested)		–	450	–	kΩ
VC input capacitance	C_{VIN}	Measurement circuit 5, V_C = 0V, f = 10kHz, Ta = 25°C (a monitor pattern on a wafer is tested)		–	37	–	pF
Modulation characteristics*1	fm	Measurement circuit 6, –3dB frequency, V_{DD} = 3.3V, V_C = 3.3Vp-p, Ta = 25°C, f_O = 27MHz		–	25	–	kHz

*1. The modulation characteristics may vary with the crystal used.

5075×J to 5075×N

V_{DD} = 2.25 to 3.63V, $V_C = 0.5V_{DD}$, V_{SS} = 0V, Ta = –40 to +85°C unless otherwise noted.

Parameter	Symbol	Conditions		Rating			Unit
				Min	Typ	Max	
Current consumption	I_{DD}	5075×J (f_O), Measurement circuit 1, no load, f_O = 48MHz, f_{OUT} = 48MHz	V_{DD} = 2.5V	–	1.2	2.4	mA
			V_{DD} = 3.3V	–	1.6	3.2	mA
		5075×K (f_O/2), Measurement circuit 1, no load, f_O = 48MHz, f_{OUT} = 24MHz	V_{DD} = 2.5V	–	0.9	1.8	mA
			V_{DD} = 3.3V	–	1.3	2.6	mA
		5075×L (f_O/4), Measurement circuit 1, no load, f_O = 48MHz, f_{OUT} = 12MHz	V_{DD} = 2.5V	–	0.8	1.6	mA
			V_{DD} = 3.3V	–	1.0	2.0	mA
		5075×M (f_O/8), Measurement circuit 1, no load, f_O = 48MHz, f_{OUT} = 6MHz	V_{DD} = 2.5V	–	0.7	1.4	mA
			V_{DD} = 3.3V	–	0.9	1.8	mA
		5075×N (f_O/16), Measurement circuit 1, no load, f_O = 48MHz, f_{OUT} = 3MHz	V_{DD} = 2.5V	–	0.7	1.4	mA
			V_{DD} = 3.3V	–	0.9	1.8	mA
HIGH-level output voltage	V_{OH}	Q pin, Measurement circuit 2, I_{OH} = –2.8mA		V_{DD} – 0.4	–	–	V
LOW-level output voltage	V_{OL}	Q pin, Measurement circuit 2, I_{OL} = 2.8mA		–	–	0.4	V
Oscillator block built-in resistance	R_{VC1}	Measurement circuit 3		210	420	840	kΩ
	R_{VC2}			210	420	840	kΩ
Oscillator block built-in capacitance	C_{VC1}	Design value (a monitor pattern on a wafer is tested), Excluding parasitic capacitance.	V_C = 0.3V	–	5.6	–	pF
			V_C = 1.65V	–	3.1	–	pF
			V_C = 3.0V	–	1.5	–	pF
	C_{VC2}		V_C = 0.3V	–	8.4	–	pF
			V_C = 1.65V	–	4.7	–	pF
			V_C = 3.0V	–	2.3	–	pF
VC input resistance	R_{VIN}	Measurement circuit 4, Ta = 25°C		10	–	–	MΩ
VC input impedance	Z_{VIN}	Measurement circuit 5, V_C = 0V, f = 10kHz, Ta = 25°C (a monitor pattern on a wafer is tested)		–	450	–	kΩ
VC input capacitance	C_{VIN}	Measurement circuit 5, V_C = 0V, f = 10kHz, Ta = 25°C (a monitor pattern on a wafer is tested)		–	37	–	pF
Modulation characteristics*1	fm	Measurement circuit 6, –3dB frequency, V_{DD} = 3.3V, V_C = 3.3Vp-p, Ta = 25°C, f_O = 48MHz		–	23	–	kHz

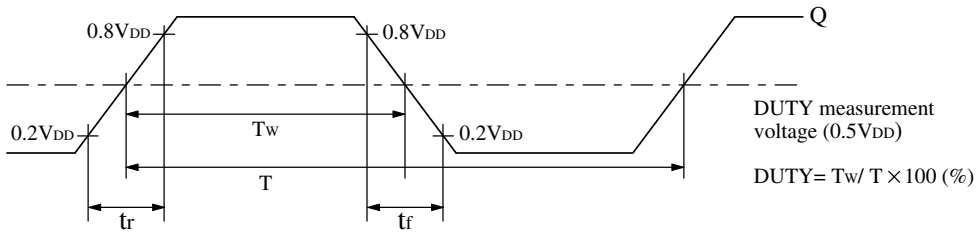
*1. The modulation characteristics may vary with the crystal used.

SWITCHING CHARACTERISTICS

V_{DD} = 2.25 to 3.63V, $V_C = 0.5V_{DD}$, V_{SS} = 0V, Ta = –40 to +85°C unless otherwise noted.

Parameter	Symbol	Conditions	Rating			Unit
			Min	Typ	Max	
Output rise time	t_r	Measurement circuit 7, $0.2V_{DD} \rightarrow 0.8V_{DD}$, C_{LOUT} = 15pF	–	2.1	4.0	ns
Output fall time	t_f	Measurement circuit 7, $0.8V_{DD} \rightarrow 0.2V_{DD}$, C_{LOUT} = 15pF	–	2.1	4.0	ns
Output duty cycle	Duty	Measurement circuit 7, Ta = 25°C, C_{LOUT} = 15pF, V_{DD} = 3.3V	45	50	55	%

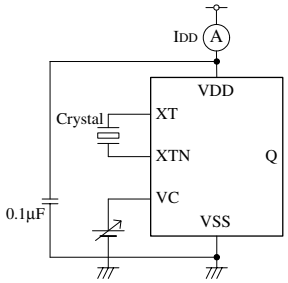
Switching Time Measurement Waveform



MEASUREMENT CIRCUITS

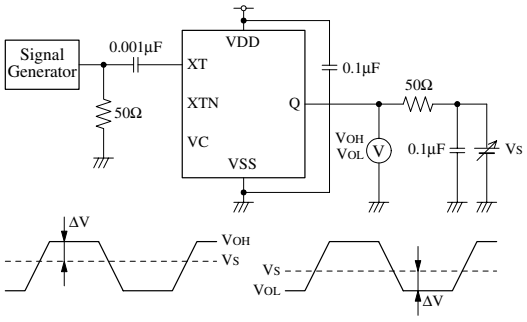
Measurement Circuit 1

Measurement parameter: I_{DD}



Measurement Circuit 2

Measurement parameter: V_{OH}, V_{OL}



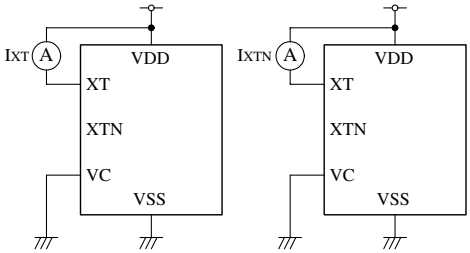
V_S adjusted such that $\Delta V = 50 \times I_{OH}$.

V_S adjusted such that $\Delta V = 50 \times I_{OL}$.

XT input signal: 1Vp-p, sine wave

Measurement Circuit 3

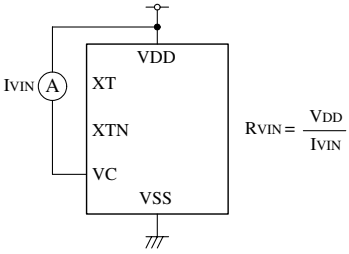
Measurement parameter: R_{VC1}, R_{VC2}



$R_{VC1} = \frac{V_{DD}}{I_{XT}}$ $R_{VC2} = \frac{V_{DD}}{I_{XTN}}$

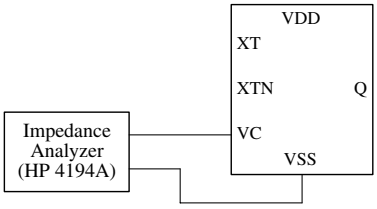
Measurement Circuit 4

Measurement parameter: R_{VIN}



Measurement Circuit 5

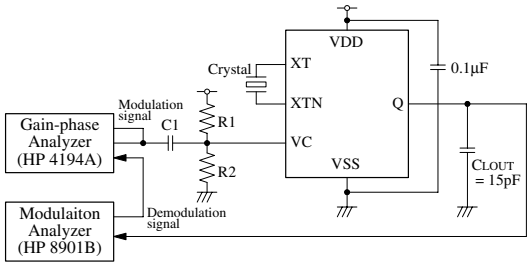
Measurement parameter: C_{VIN}, Z_{VIN}



VC input signal: 100Hz to 10kHz, 0.1Vp-p

Measurement Circuit 6

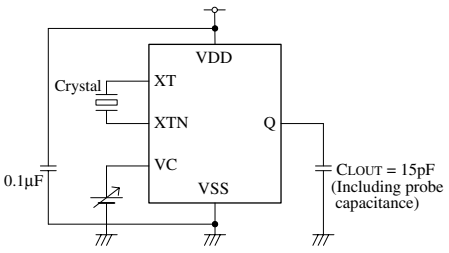
Measurement parameter: fm



C1 = 33µF, R1 = R2 = 1MΩ
VC modulation signal: 100Hz to 100kHz, 0 to V_{DD}p-p

Measurement Circuit 7

Measurement parameter: Duty, t_r , t_f



FUNCTIONAL DESCRIPTION

Oscillation Start-up Detector Function

The devices also feature an oscillation start-up detector circuit. This circuit functions to disable the outputs until the oscillation starts. This prevents unstable oscillator output at oscillator start-up when power is applied.

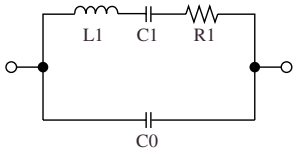
TYPICAL PERFORMANCE (5075B1)

The following characteristics measured using the crystal below. Note that the characteristics will vary with the crystal used.

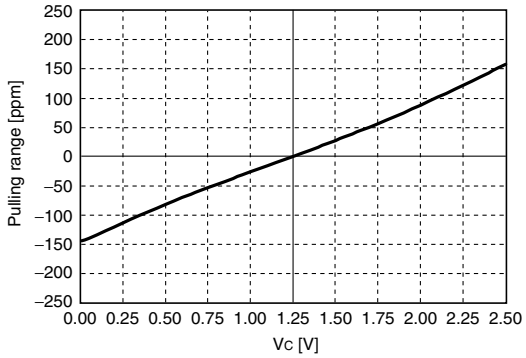
■ Crystal used for measurement

Parameter	f_O = 27MHz
C0 [pF]	1.5
γ (= C0/C1)	300

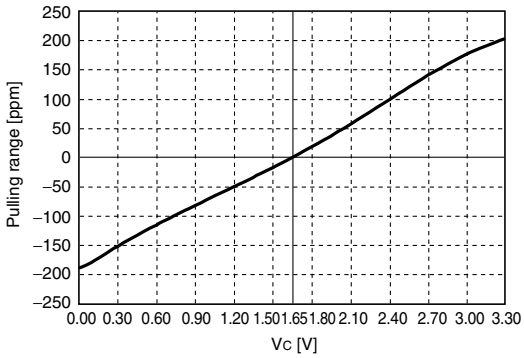
■ Crystal parameters



Frequency Pulling Range

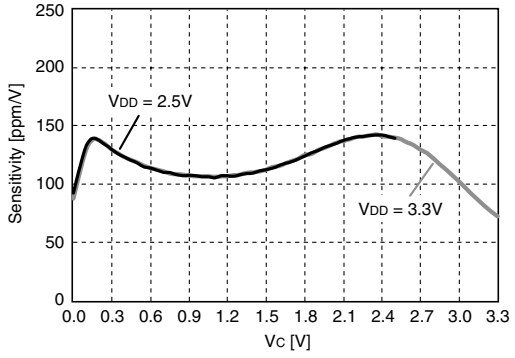


V_{DD} = 2.5V, f_{OUT} = 27MHz, Ta = R.T.



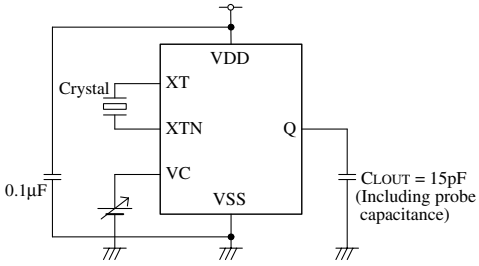
V_{DD} = 3.3V, f_{OUT} = 27MHz, Ta = R.T.

Pulling Sensitivity

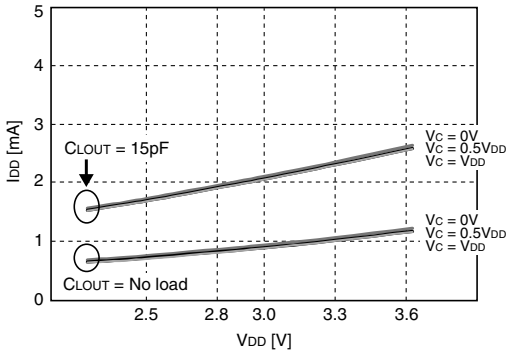


V_{DD} = 2.5V, 3.3V, f_{OUT} = 27MHz, Ta = R.T.

Measurement circuit

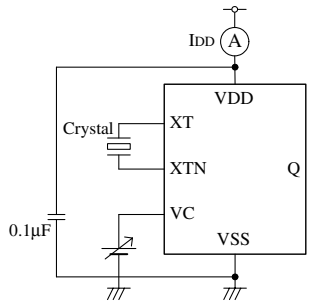


Current Consumption

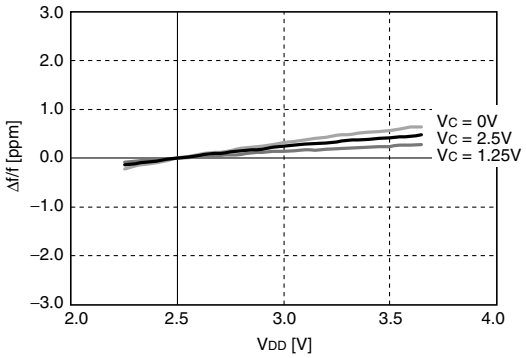


f_{OUT} = 27MHz, Ta = R.T.

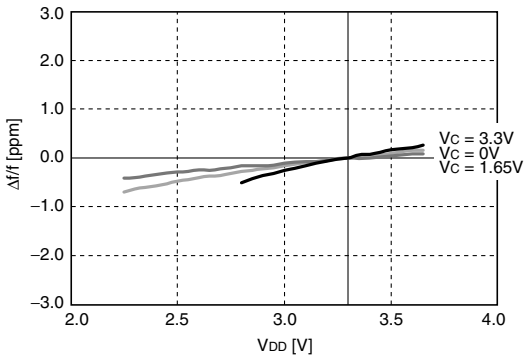
Measurement circuit



Frequency Stability by Supply Voltage Change

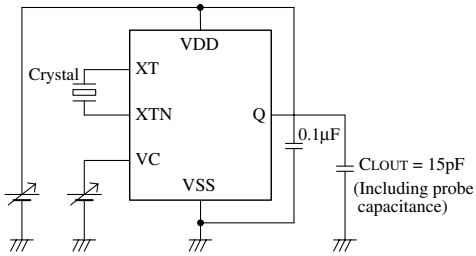


f_{OUT} = 27MHz, ± 0ppm at V_{DD} = 2.5V

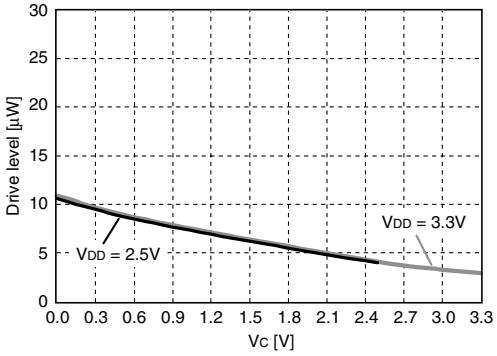


f_{OUT} = 27MHz, ± 0ppm at V_{DD} = 3.3V

Measurement circuit

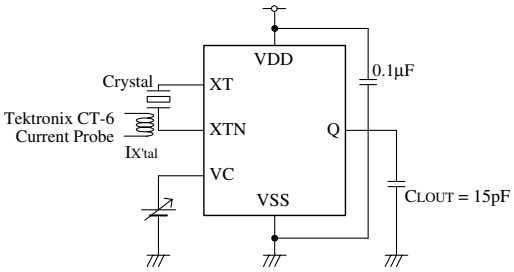


Drive Level



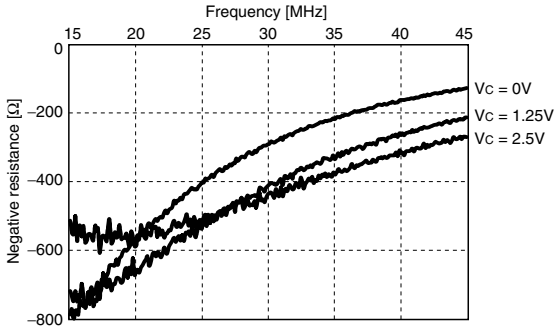
V_{DD} = 2.5V, 3.3V, f_{OUT} = 27MHz, Ta = R.T.

Measurement circuit

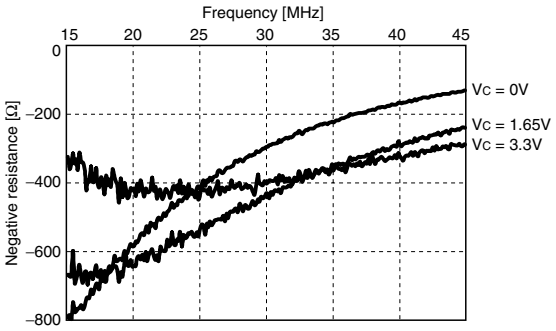


$DL = (I_{X'tal})^2 \times Re$
DL: drive level
$I_{X'tal}$: current flowing to crystal (RMS value)
Re: crystal effective resistance

Negative Resistance

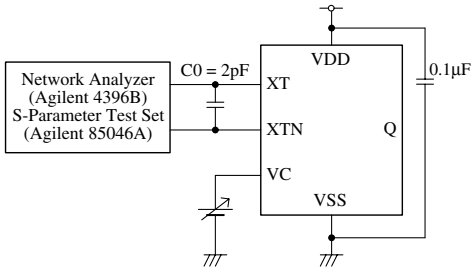


V_{DD} = 2.5V, C0 = 2pF, Ta = R.T.



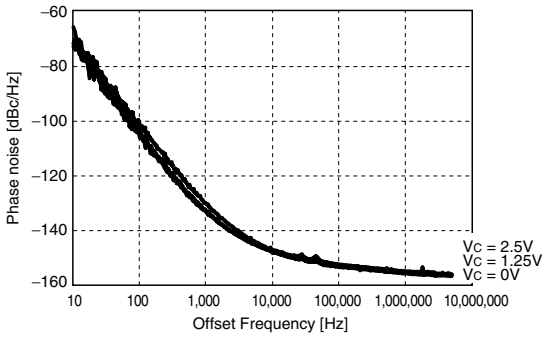
V_{DD} = 3.3V, C0 = 2pF, Ta = R.T.

Measurement circuit

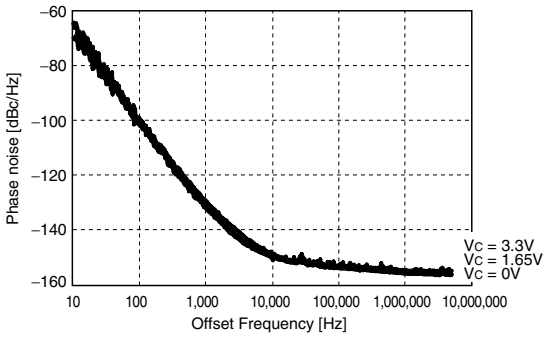


Note. "C0" value is set, concerning the actual crystal characteristics connected between XT and XTN. The data is measured with Agilent 4396B using NPC's original measurement jig. The values may vary with measurement jig and conditions.

Phase Noise

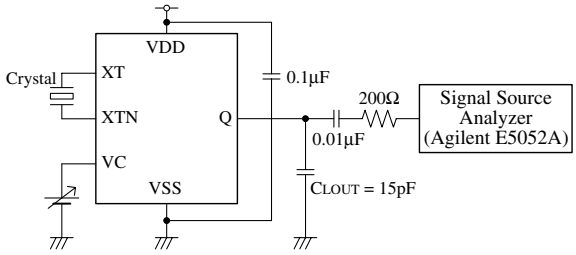


V_{DD} = 2.5V, f_{OUT} = 27MHz, Ta = R.T.

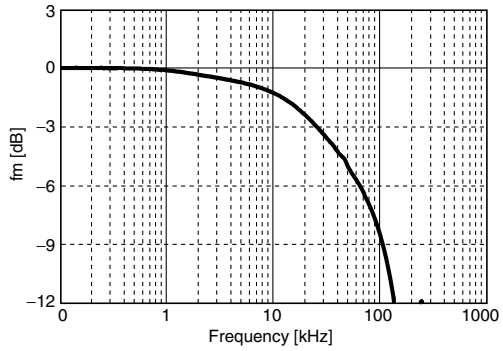


V_{DD} = 3.3V, f_{OUT} = 27MHz, Ta = R.T.

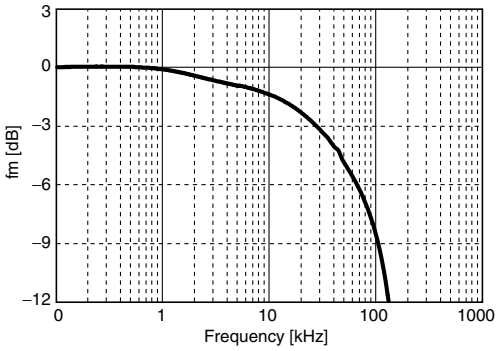
Measurement circuit



Modulation Characteristics

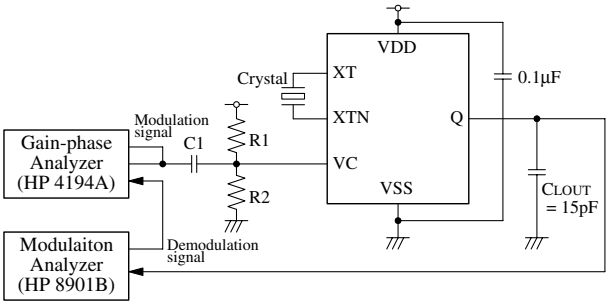


V_{DD} = 2.5V, f_{OUT} = 27MHz, Ta = R.T.



V_{DD} = 3.3V, f_{OUT} = 27MHz, Ta = R.T.

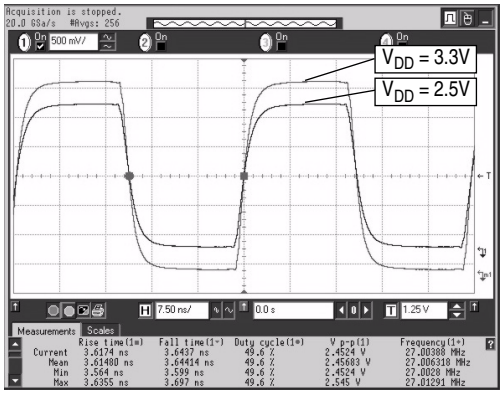
Measurement circuit



C1 = 33µF, R1 = R2 = 1MΩ
VC modulation signal: 100Hz to 100kHz, 0 to V_{DD}p-p

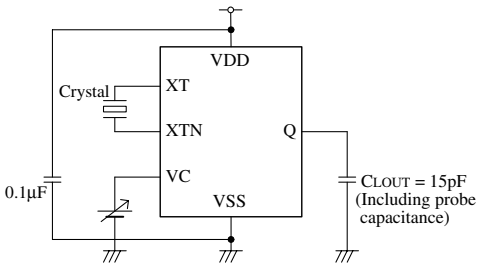
Output Waveform

Measurement equipment: Oscilloscope; DSO80604B (Agilent)



V_{DD} = 2.5V, 3.3V, f_{OUT} = 27MHz, V_C = 0.5V_{DD},
C_{LOUT} = 15pF, Ta = R.T.

Measurement circuit



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